

**FEATURES:**

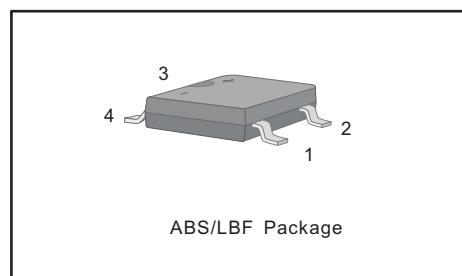
- Glass Passivated Chip Junction
- Reverse Voltage - 100 to 1000 V
- Forward Current - 1 A
- High Surge Current Capability
- Designed for Surface Mount Application

**PINNING**

PIN	DESCRIPTION
1	Input Pin ( ~ )
2	Input Pin ( ~ )
3	Output Anode ( + )
4	Output Cathode ( - )

**MECHANICAL DATA**

- Case: ABS/LBF
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 88mg / 0.0031oz

**Maximum Ratings and Electrical characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified.

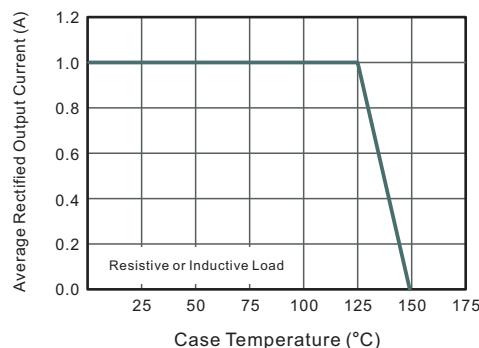
Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	ABS1	ABS2	ABS4	ABS6	ABS8	ABS10	Units
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	100	200	400	600	800	1000	V
Maximum RMS voltage	V <sub>RMS</sub>	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	V <sub>DC</sub>	100	200	400	600	800	1000	V
Average Rectified Output Current at T <sub>c</sub> = 125 °C	I <sub>o</sub>	1						A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I <sub>FSM</sub>	35						A
Forward Voltage per element @I <sub>F</sub> =1.0A	V <sub>F</sub>	1.1						V
Maximum DC Reverse Current @T <sub>A</sub> =25 °C @T <sub>A</sub> =100°C @T <sub>A</sub> =125 °C	I <sub>R</sub>	5 50 100						µA
Typical Junction Capacitance ( Note1 )	C <sub>j</sub>	13						pF
Typical Thermal Resistance ( Note2 )	R <sub>θJA</sub> R <sub>θJC</sub>	72 20						°C/W
Operating and Storage Temperature Range	T <sub>j</sub> , T <sub>stg</sub>	-55 ~ +150						°C

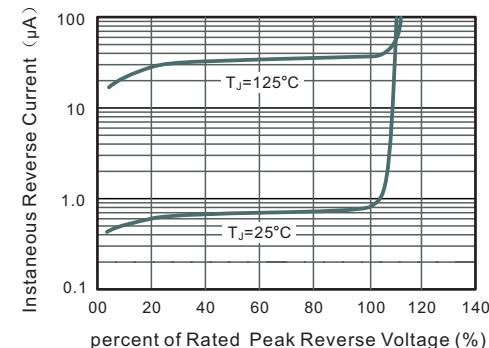
Note: 1. Measured at 1MHz and applied reverse voltage of 4 V D.C.

2. Mounted on glass epoxy PC board with 4×1.5"×1.5" ( 3.81×3.81 cm ) copper pad.

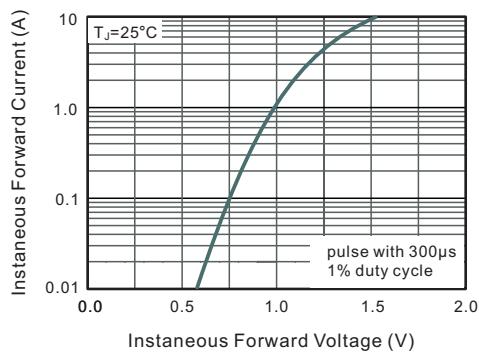
**Fig.1 Average Rectified Output Current Derating Curve**



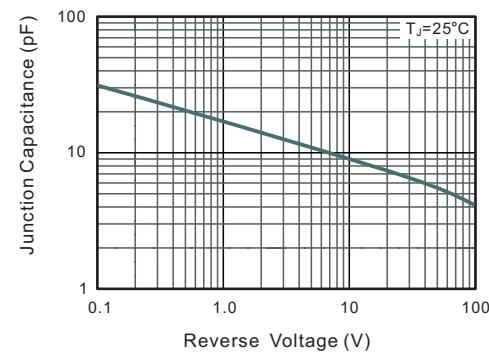
**Fig.2 Typical Reverse Characteristics**



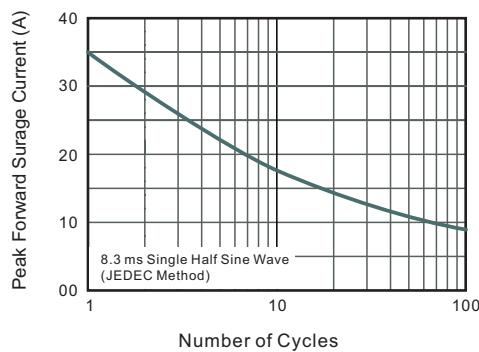
**Fig.3 Typical Instantaneous Forward Characteristics**



**Fig.4 Typical Junction Capacitance**

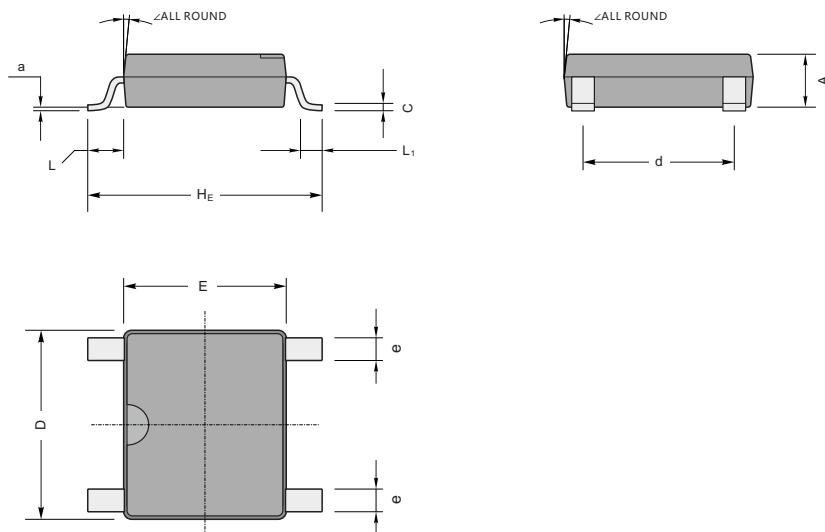


**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



## PACKAGE OUTLINE

Plastic surface mounted package; 4 leads



ABS/LBF mechanical data

UNIT		A	C	D	E	H <sub>E</sub>	d	e	L	L <sub>1</sub>	a	<	
mm	max	1.5	0.22	5.2	4.5	6.4	4.2	0.7	0.95	0.6	0.2	7°	
	min	1.3	0.15	4.9	4.2	6.0	3.8	0.5					
mil	max	59	8.7	205	177	252	165	28	37	24	8		
	min	51	5.9	193	166	236	150	20					

### The recommended mounting pad size

